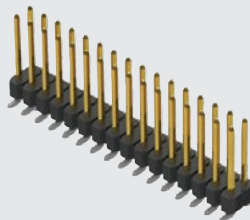




(2.54 mm) .100"

TSM-116-02-S-DV-LC



TSM-121-01-T-SV



SMT .025" SQ POST HEADER

Board Mates:

SSW, SSQ, SSM, BSW, ESW, ESQ, BCS, SLW, CES, HLE

Cable Mates:

IDSS, IDSD, SMSD, SMSS

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?TSM

Insulator Material:

Black Liquid Crystal Polymer

Terminal Material:

Phosphor Bronze

Plating:

Au or Sn over

50 μ" (1.27 μm) Ni

Operating Temp Range:

-55 °C to +105 °C with Tin;

-55 °C to +125 °C with Gold

Voltage Rating:

475 VAC -SV/-DV mated with

BCS or SSM

RoHS Compliant: Yes

MATES	CURRENT RATING (PER PIN)
TSM/SSW	4.7 A
TSM/SSM	5.4 A
TSM/HLE	4.1 A
2 PINS POWERED	

PROCESSING

Lead-Free Solderable: Yes

-DH/-SH Lead Coplanarity:
(0.15 mm) .006" max (02-36)*

-DV/-SV Lead Coplanarity:
(0.10 mm) .004" max (02-05)
(0.13 mm) .005" max (06-10)*
(0.15 mm) .006" max (11-36)*

*(.004" stencil solution may be available; contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

- Edge Mount and Locking Clips for -SV
 - Solder Locks for -DH and Shrouds for -DV
 - Other platings
- Contact Samtec.

Note: Some lengths, styles and options are non-standard, non-returnable.

TSM

1

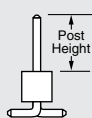
NO. PINS PER ROW

LEAD STYLE

PLATING OPTION

ROW OPTION

02 thru 36



-01 = .230" (5.84 mm) Post Height
(Mates with SSW, BCS, SSM, IDSS, IDSD)

-02 = .320" (8.13 mm) Post Height
(Mates with SSM -DH)

-03 = .420" (10.67 mm) Post Height
(For Bottom Mount & Pass Through)

-04 = .120" (3.05 mm) Post Height
(Mates with SLW, CES, HLE)

-F
= Gold flash on post,
Matte Tin on tail

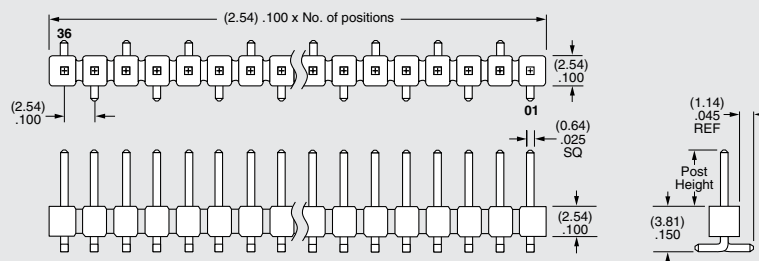
-L
= 10 μ" (0.25 μm) Gold on post,
Matte Tin on tail

-S
= 30 μ" (0.76 μm) Gold on post,
Matte Tin on tail

-T
= Matte Tin

-SV

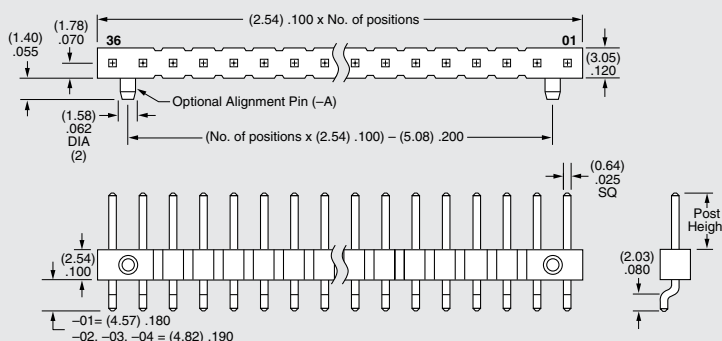
= Single Row Vertical Pin



APPLICATIONS

**-SH**

= Single Row Horizontal Pin

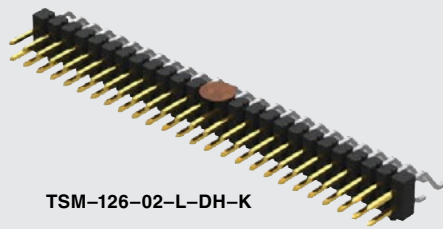


Due to technical progress, all designs, specifications and components are subject to change without notice.

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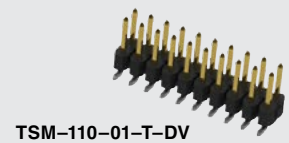
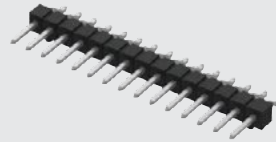
All parts within this catalog are built to Samtec's specifications.

Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.



TSM-126-02-L-DH-K

TSM-115-01-T-SH-A



TSM-110-01-T-DV

TSM SERIES

OTHER OPTIONS

-A

= Alignment Pin
metal or plastic
at Samtec discretion
(Not available
with -TM or -MT)
(02 positions min.)
(Not available with -LC)

-LC

= Locking Clip
(Not available with -TM)
(3 positions min.)
(Not available with -A)
(Manual placement
required)

-K

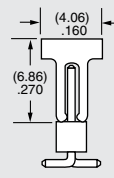
= (6.50 mm) .256" DIA
Polyimide Film
Pick & Place Pad
(-SH: 4 positions
minimum without -TR;
2 & 3 positions
available with -TR)
(-DH: 4 positions
minimum
without -TR)

-“XXX”

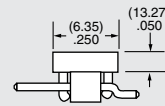
= Polarized
Position

-P

= Plastic Pick & Place Pad
(-DV: 4 positions minimum
without -TR; 2 & 3 positions
available with -TR)
(-SH: 4 positions
minimum without -TR;
2 & 3 positions
available with -TR)
(-DH: 5 positions
minimum without -TR)
(-SV: 4 positions
minimum without -TR;
2 & 3 positions
available with -TR)



-SV



-SH & -DH

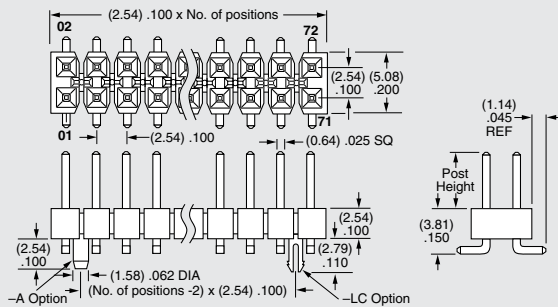
-TR

= Tape & Reel Packaging
-SV = 02-22 positions
-DV = 02-28 positions
-SH = 02-30 positions
-DH = 02-29 positions

Not available with -MT or -TM

-DV

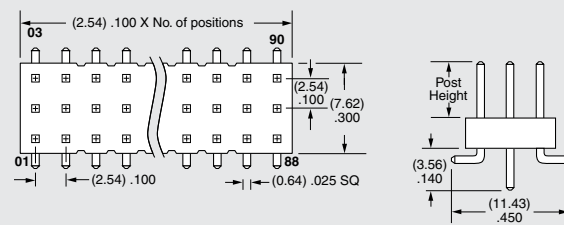
= Double Row Vertical Pin



-TM

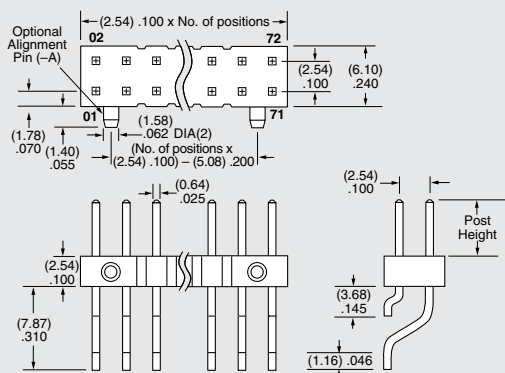
= Triple Row Vertical Mixed Technology (Style -01 only)

02 thru 30 positions only



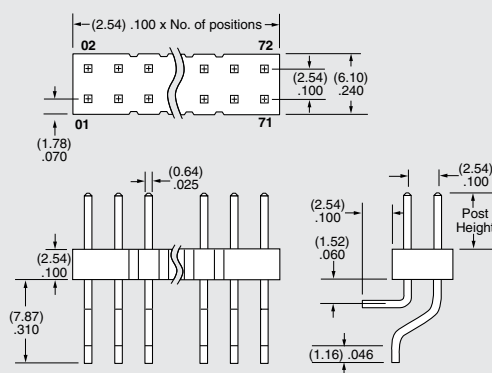
-DH

= Double Row Horizontal Pin
(Style -01, -02 or -03 only)



-MT

= Mixed Technology Pin
(Style -01, -02 or -03 only)



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